

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Michael C. LOO	11/16/2008
RECEIVING PARTY DATA	
Name:	NXP B.V.
Street Address:	High Tech Campus 60
City:	Eindhoven
State/Country:	NETHERLANDS
Postal Code:	5656 AG
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12090686
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NAME OF SUBMITTER:	Vilimaina Naga
Total Attachments: 1 source=003728_ASSIGN_2008-11-16#page1.tif	

CH \$40.00 12090686

SOLE ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, I, as a below-named Assignor, hereby sell, assign, and transfer the entire and exclusive right, title, and interest in the following to NXP B.V., having a place of business at High Tech Campus 60, 5656 AG, Eindhoven, NL, its successors, assigns, and legal representatives, including any nominees (collectively "the Assignee"):

(1) my invention relating to "REDISTRIBUTION LAYER FOR WAFER-LEVEL CHIP SCALE PACKAGE AND METHOD THEREFOR" for which a U.S. provisional patent application was filed in the United States Patent and Trademark Office on 10/19/2005, having a Serial Number 60/728,553.

(2) the foregoing application and all other United States, foreign and international patent applications associated therewith, based thereon, or claiming priority there from including, but not limited to, any and all provisional's, non-provisional's, divisions, continuations, continuations-in-part, re-examinations, reissues, and extensions thereof, and

(3) the right to claim priority thereto, and the entire and exclusive right, title, and interest in and to any and all patents granted on these applications.

I authorize and request that the Patent Office officials in the United States and in any and all foreign countries to issue any and all Letters Patent when granted, solely to NXP B.V., for its sole use, and that of its successors, assigns, and legal representatives.

I will provide my cooperation to enable the Assignee to enjoy the foregoing right, title, and interest to the fullest extent. Upon request at the expense of the Assignee, I agree to execute all papers, take all rightful oaths, testify in all legal proceedings including patent prosecutorial actions and infringement actions, and do all other such acts which may be necessary, desirable, or convenient for securing and maintaining patents on the foregoing invention or for perfecting title thereto in the Assignee.

I certify that I have the full right to convey the above rights.

11/16/08 Date Michael C. LOO Assignor

____ Date _____ Assignor

____ Date _____ Assignor